

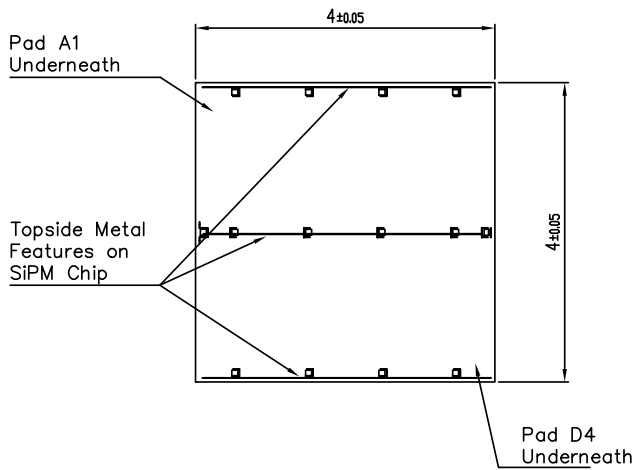
# MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

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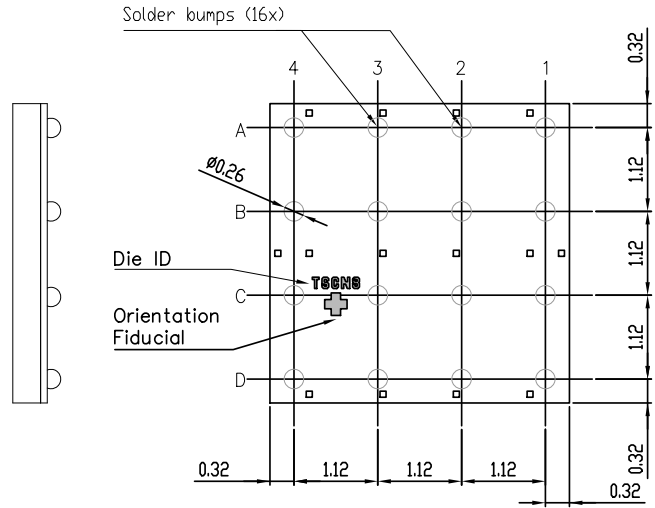


## ODCSP16 4x4, 1.12P CASE 570CN ISSUE O

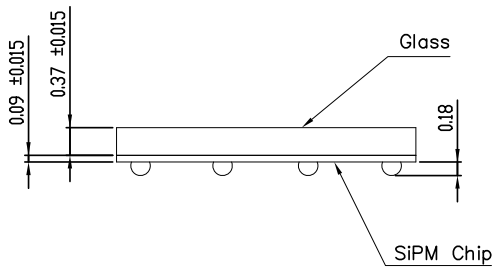
DATE 31 JUL 2018



Top View  
Scale 20:1

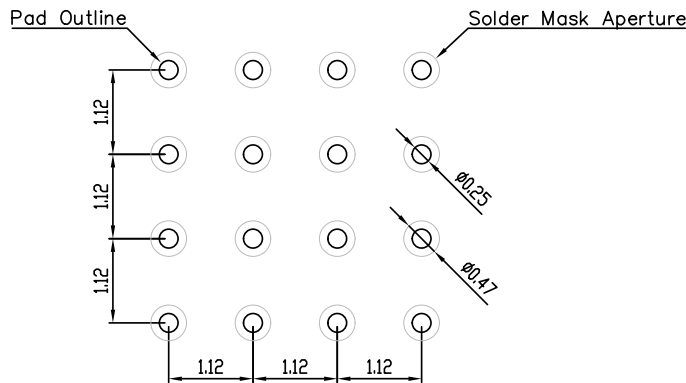


Bottom View  
Scale 20:1



Side View  
Scale 20:1

Pad Assignment			
Pad #	Function	Pad #	Function
A1	Cathode	C1	Anode
A2	No Connect	C2	No Connect
A3	No Connect	C3	No Connect
A4	No Connect	C4	Fast
B1	Anode	D1	No Connect
B2	No Connect	D2	No Connect
B3	No Connect	D3	No Connect
B4	Fast	D4	Cathode



Recommended PCB Solder Footprint  
Scale 20:1

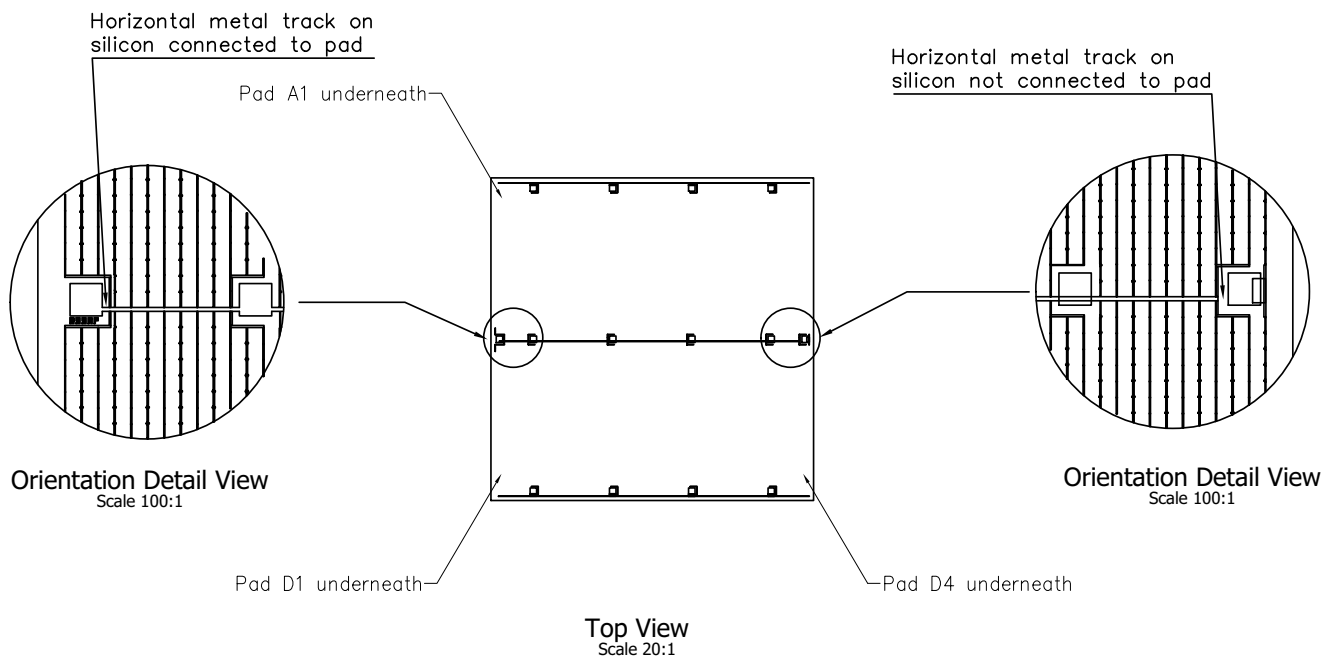
NOTE: The No Connect (NC) pins are electrically isolated and should be soldered to a ground (or bias) plane to help with heat dissipation.

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<b>DESCRIPTION:</b>	<b>ODCSP16 4x4, 1.12P</b>	<b>PAGE 1 OF 2</b>


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**ODCSP16 4x4, 1.12P**  
**CASE 570CN**  
**ISSUE O**

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